# MO1602

# Low Power, Standard Frequency Oscillator



#### **Features**

- 52 standard frequencies between 3.57 MHz and 77.76 MHz
- 100% pin-to-pin drop-in replacement to quartz-based XO
- Excellent total frequency stability as low as ±20 ppm
- Operating temperature from -40°C to +85°C. For +125°C and/or -55°C options, refer to MO1618, MO8918
- Low power consumption of +3.5 mA typical at 20 MHz, +1.8V
- Standby mode for longer battery life
- Fast startup time of 5 ms
- LVCMOS/HCMOS compatible output
- Industry-standard packages: 2.0 x 1.6, 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 mm x mm
- Instant samples with Time Machine II and field programmable oscillators
- RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free
- For AEC-Q100 oscillators, refer to MO8924 and MO8925

## **Applications**

- Ideal for DSC, DVC, DVR, IP CAM, Tablets, e-Books, SSD, GPON, EPON, etc
- Ideal for high-speed serial protocols such as: USB, SATA, SAS, Firewire, 100M / 1G / 10G Ethernet, etc





RoHS Complian

# **Electrical Specifications**

#### **Table 1. Electrical Characteristics**

All Min and Max limits are specified over temperature and rated operating voltage with 15 pF output load unless otherwise stated. Typical values are at +25°C and nominal supply voltage.

| Parameters                   | Symbol | Min.  | Тур.                          | Max.          | Unit         | Condition  |
|------------------------------|--------|-------|-------------------------------|---------------|--------------|--|
|                              |        | _     | F                             | requency Ra   | ange         |  |
| Output Frequency Range       | f      |       | rd frequencie<br>1Hz and 77.7 |               | MHz          | Refer to Table 13 for the exact list of supported frequencies  |
|                              |        |       | Frequer                       | ncy Stability | and Aging    |  |
|                              |        | -20   | -                             | +20           | ppm          | Inclusive of initial tolerance at +25°C, 1st year aging at +25°C,  |
| Frequency Stability          | F_stab | -25   | -                             | +25           | ppm          | and variations over operating temperature, rated power supply  |
|                              |        | -50   | -                             | +50           | ppm          | voltage and load.  |
|                              | _      |       | Operati                       | ng Tempera    | ture Range   |  |
| Operating Temperature Range  | T use  | -20   | -                             | +70           | °C           | Extended Commercial  |
| Operating reinperature range | 1_030  | -40   | -                             | +85           | °C           | Industrial   |
|                              | _      | S     | upply Voltag                  | e and Curre   |              | nption   |
|                              |        | +1.62 | +1.8                          | +1.98         | V            |  |
|                              |        | +2.25 | +2.5                          | +2.75         | V            |  |
| Supply Voltage               | Vdd    | +2.52 | +2.8                          | +3.08         | V            | Contact KDS for +1.5V support  |
| Supply Voltage               | Vuu    | +2.7  | +3.0                          | +3.3          | V            | Contact NDS for +1.5V support  |
|                              |        | +2.97 | +3.3                          | +3.63         | V            |  |
|                              |        | +2.25 | -                             | +3.63         | V            |  |
|                              |        | -     | +3.8                          | +4.5          | mA           | No load condition, f = 20 MHz, Vdd = +2.8V to +3.3V  |
| Current Consumption          | Idd    | -     | +3.7                          | +4.2          | mA           | No load condition, f = 20 MHz, Vdd = +2.5V   |
|                              |        | -     | +3.5                          | +4.1          | mA           | No load condition, f = 20 MHz, Vdd = +1.8V   |
| OE Disable Current           | I OD   | -     | -                             | +4.2          | mA           | Vdd = +2.5V to +3.3V, OE = GND, Output in high-Z state   |
| OE Disable Current           | I_OD   | -     | -                             | +4.0          | mA           | Vdd = +1.8V, OE = GND, Output in high-Z state  |
|                              |        | -     | +2.1                          | +4.3          | μΑ           | $\overline{ST}$ = GND, Vdd = +2.8V to +3.3V, Output is weakly pulled down  |
| Standby Current              | I_std  | _     | +1.1                          | +2.5          | μΑ           | $\overline{ST}$ = GND, Vdd = +2.5V, Output is weakly pulled down   |
|                              |        | -     | +0.2                          | +1.3          | μΑ           | ST = GND, Vdd = +1.8V, Output is weakly pulled down  |
|                              |        |       | LVCMOS                        | Output Cha    | aracteristic | s  |
| Duty Cycle                   | DC     | 45    | -                             | 55            | %            | All Vdds. See Duty Cycle definition in Figure 3 and Footnote 6   |
|                              |        | _     | 1.0                           | 2.0           | ns           | Vdd = +2.5V, +2.8V, +3.0V or +3.3V, 20% - 80%  |
| Rise/Fall Time               | Tr, Tf | -     | 1.3                           | 2.5           | ns           | Vdd =+1.8V, 20% - 80%  |
|                              |        | -     | -                             | 2.0           | ns           | Vdd = +2.25V - +3.63V, 20% - 80%   |
| Output High Voltage          | VOH    | 90%   | -                             | -             | Vdd          | IOH = -4.0 mA (Vdd = +3.0V or +3.3V)<br>IOH = -3.0 mA (Vdd = +2.8V and Vdd = +2.5V)<br>IOH = -2.0 mA (Vdd = +1.8V) |
| Output Low Voltage           | VOL    | -     | -                             | 10%           | Vdd          | IOL = +4.0 mA (Vdd = +3.0V or +3.3V)<br>IOL = +3.0 mA (Vdd = +2.8V and Vdd = +2.5V)<br>IOL = +2.0 mA (Vdd = +1.8V) |



**Table 1. Electrical Characteristics (continued)** 

| Parameters                   | Symbol                | Min.  | Тур.                    | Max.  | Unit      | Condition   |
|------------------------------|-----------------------|---|-------------------------|---|-----------|---|
|                              |                       |   | Inp                     | ut Characte   | eristics  |   |
| Input High Voltage           | VIH                   | 70%   | -                       | -   | Vdd       | Pin 1, OE or ST   |
| Input Low Voltage            | VIL                   | -   | -                       | 30%   | Vdd       | Pin 1, OE or ST   |
| Innut Bull un Imnadance      | 7 in                  | . 50 87 150 kΩ Pin 1, OE logic high or logic low, or ST |                         | Pin 1, OE logic high or logic low, or ST logic high |           |   |
| Input Pull-up Impedance      | Z_in                  | 2.0   | -                       | -   | МΩ        | Pin 1, ST logic low   |
|                              |                       |   | Startu                  | p and Resu  | me Timing |   |
| Startup Time                 | T_start               | -   | -                       | 5.0   | ms        | Measured from the time Vdd reaches its rated minimum value      |
| Enable/Disable Time          | T_oe                  | -   | -                       | 138   | ns        | f = 77.76 MHz. For other frequencies, T_oe = 100 ns + 3 *cycles |
| Resume Time                  | T_resume              | -   | -                       | 5.0   | ms        | Measured from the time ST pin crosses 50% threshold             |
|                              |                       |   |                         | Jitter  |           |   |
| RMS Period Jitter            | Т ::#                 | -   | 1.8                     | 3.0   | ps        | f = 75 MHz, Vdd = +2.5V, +2.8V, +3.0V or +3.3V                  |
| RMS Period Sitter            | T_jitt                | -   | 1.8                     | 3.0   | ps        | f = 75 MHz, Vdd = +1.8V   |
| Pook to pook Poriod litter   | T nl                  | -   | 12                      | 25  | ps        | f = 75 MHz, Vdd = +2.5V, +2.8V, +3.0V or +3.3V                  |
| Peak-to-peak Period Jitter   | to-peak Period Jitter |   | f = 75 MHz, Vdd = +1.8V |   |           |   |
| RMS Phase Jitter (random)    | T phi                 | -   | 0.5                     | 0.9   | ps        | f = 75 MHz, Integration bandwidth = 900 kHz to 7.5 MHz          |
| NWO FIIASE JILLE! (TATICOTT) | T_phj                 | _   | 1.3                     | 2.0   | ps        | f = 75 MHz, Integration bandwidth = 12 kHz to 20 MHz            |

# **Table 2. Pin Description**

| Pin | Symbol     |                  | Functionality  |
|-----|------------|------------------|--|
|     |            | Output<br>Enable | H <sup>[1]</sup> : specified frequency output<br>L: output is high impedance. Only output driver is disabled.                                |
| 1   | OE/ ST/NC  | Standby          | H <sup>[1]</sup> : specified frequency output L: output is low (weak pull down). Device goes to sleep mode. Supply current reduces to I_std. |
|     | No Connect |                  | Any voltage between 0 and Vdd or Open <sup>[1]</sup> : Specified frequency output. Pin 1 has no function.                                    |
| 2   | GND        | Power            | Electrical ground  |
| 3   | OUT        | Output           | Oscillator output  |
| 4   | VDD        | Power            | Power supply voltage <sup>[2]</sup>  |

# OE/ST/NC 1 4 VDD

GND

**Top View** 

Figure 1. Pin Assignments

OUT

#### Notes

- 1. In OE or  $\overline{ST}$  mode, a pull-up resistor of 10 k $\Omega$  or less is recommended if pin 1 is not externally driven. If pin 1 needs to be left floating, use the NC option.
- 2. A capacitor of value 0.1  $\mu\text{F}$  or higher between Vdd and GND is required.



#### **Table 3. Absolute Maximum Limits**

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter  | Min. | Max.  | Unit |
|--|------|-------|------|
| Storage Temperature  | -65  | +150  | °C   |
| Vdd  | -0.5 | +4.0  | V    |
| Electrostatic Discharge  | -    | +2000 | V    |
| Soldering Temperature (follow standard Pb free soldering guidelines) | -    | +260  | °C   |
| Junction Temperature <sup>[3]</sup>                                  | -    | +150  | °C   |

#### Note:

# Table 4. Thermal Consideration<sup>[4]</sup>

| Package | θJA, 4 Layer Board<br>(°C/W) | θJA, 2 Layer Board<br>(°C/W) | θJC, Bottom<br>(°C/W) |
|---------|------------------------------|------------------------------|-----------------------|
| 7050    | 142                          | 273                          | 30                    |
| 5032    | 97                           | 199                          | 24                    |
| 3225    | 109                          | 212                          | 27                    |
| 2520    | 117                          | 222                          | 26                    |
| 2016    | 152                          | 252                          | 36                    |

#### Note:

# Table 5. Maximum Operating Junction Temperature<sup>[5]</sup>

| Max Operating Temperature (ambient) | Maximum Operating Junction Temperature |
|-------------------------------------|--|
| +70°C                               | +80°C                                  |
| +85°C                               | +95°C                                  |

#### Note:

# **Table 6. Environmental Compliance**

| Parameter                  | Condition/Test Method    |
|----------------------------|--------------------------|
| Mechanical Shock           | MIL-STD-883F, Method2002 |
| Mechanical Vibration       | MIL-STD-883F, Method2007 |
| Temperature Cycle          | JESD22, Method A104      |
| Solderability              | MIL-STD-883F, Method2003 |
| Moisture Sensitivity Level | MSL1 @ 260°C             |

<sup>3.</sup> Exceeding this temperature for extended period of time may damage the device.

<sup>4.</sup> Refer to JESD51 for  $\theta$ JA and  $\theta$ JC definitions, and reference layout used to determine the  $\theta$ JA and  $\theta$ JC values in the above table.

<sup>5.</sup> Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.



# Test Circuit and Waveform<sup>[6]</sup>

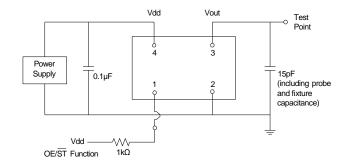


Figure 2. Test Circuit

#### Note:

6. Duty Cycle is computed as Duty Cycle = TH/Period.

# **Timing Diagrams**

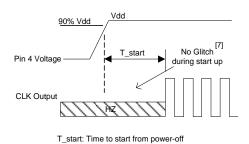


Figure 4. Startup Timing (OE/STMode)

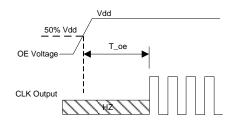


Figure 6. OE Enable Timing (OE Mode Only)

T\_oe: Time to re-enable the clock output

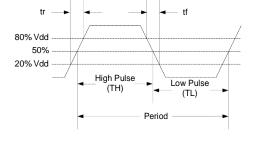
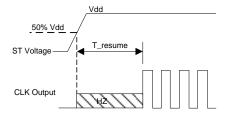
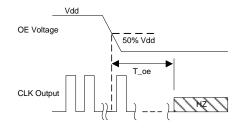


Figure 3. Waveform



T\_resume: Time to resume from ST

Figure 5. Standby Resume Timing (ST Mode Only)



 $T\_$ oe: Time to put the output in High Z mode

Figure 7. OE Disable Timing (OE Mode Only)

#### Note:

7. MO1602 has "no runt" pulses and "no glitch" output during startup or resume.



# Performance Plots<sup>[8]</sup>

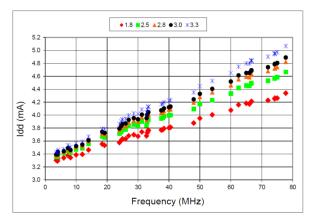


Figure 8. Idd vs Frequency

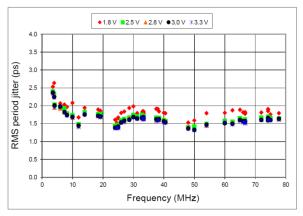


Figure 10. RMS Period Jitter vs Frequency

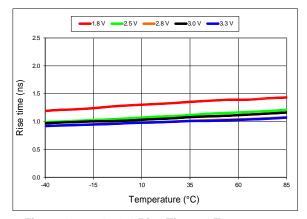


Figure 12. 20%-80% Rise Time vs Temperature

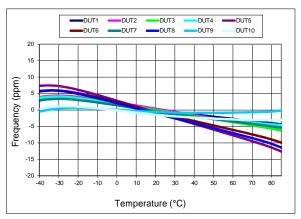


Figure 9. Frequency vs Temperature

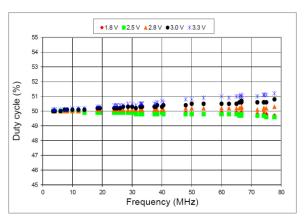


Figure 11. Duty Cycle vs Frequency

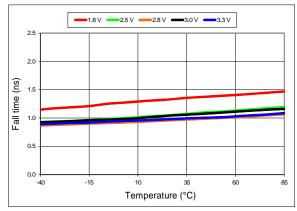
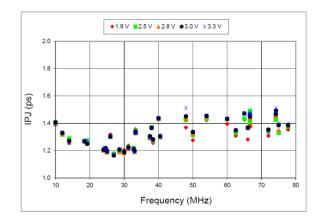


Figure 13. 20%-80% Fall Time vs Temperature



# Performance Plots<sup>[8]</sup>



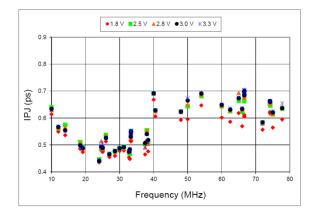


Figure 14. RMS Integrated Phase Jitter Random (12 kHz to 20 MHz) vs Frequency<sup>[9]</sup>

Figure 15. RMS Integrated Phase Jitter Random (900 kHz to 20 MHz) vs Frequency<sup>[9]</sup>

#### Notes

- 8. All plots are measured with 15 pF load at room temperature, unless otherwise stated.
- 9. Phase noise plots are measured with Agilent E5052B signal source analyzer. Integration range is up to 5 MHz for carrier frequencies below 40 MHz.



#### **Programmable Drive Strength**

The MO1602 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

For more detailed information about rise/fall time control and drive strength selection, contact KDS.

#### **EMI Reduction by Slowing Rise/Fall Time**

Figure 16 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the rise/fall times are very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.

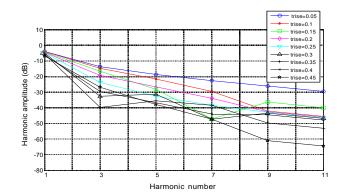


Figure 16. Harmonic EMI reduction as a Function of Slower Rise/Fall Time

#### Jitter Reduction with Faster Rise/Fall Time

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to speed up the rise/fall time of the input clock. Some chipsets may also require faster rise/fall time in order to reduce their sensitivity to this type of jitter. Refer to the Rise/Fall Time Tables (Table 7 to Table 11) to determine the proper drive strength.

#### **High Output Load Capability**

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a +3.3V MO1602 device with default drive strength setting, the typical rise/fall time is 1 ns for 15 pF output load. The typical rise/fall time slows down to 2.6 ns when the output load increases to 45 pF. One can choose to speed up the rise/fall time to 1.83 ns by then increasing the drive strength setting on the MO1602.

The MO1602 can support up to 60 pF or higher in maximum capacitive loads with drive strength settings. Refer to the Rise/Tall Time Tables (Table 7 to 11) to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

#### MO1602 Drive Strength Selection

Tables 7 through 11 define the rise/fall time for a given capacitive load and supply voltage.

- 1. Select the table that matches the MO1602 nominal supply voltage (+1.8V, +2.5V, +2.8V, +3.0V, +3.3V).
- 2. Select the capacitive load column that matches the application requirement (5 pF to 60 pF)
- 3. Under the capacitive load column, select the desired rise/fall times.
- The left-most column represents the part number code for the corresponding drive strength.
- Add the drive strength code to the part number for ordering purposes.

Maximum Frequency Calculation

Any given rise/fall time in Table 7 through 11 dictates the maximum frequency under which the oscillator can operate with guaranteed full output swing over the entire operating temperature range. This max frequency can be calculated as the following:

$$Max Frequency = \frac{1}{5 \times Trf_{20/80}}$$

where  $Trf_{20/80}$  is the typical value for 20%-80% rise/fall time.

## Example 1

Calculate f<sub>MAX</sub> for the following condition:

- Vdd = +1.8V (Table 1)
- · Capacitive Load: 30 pF
- Desired Tr/f time = 3 ns (rise/fall time part number code = E)
- $f_{MAX} = 66.66660$

Part number for the above example: MO1602IG4-CEH-18E0-0066666660



Drive strength code is here.



# Rise/Fall Time (20% to 80%) vs C<sub>LOAD</sub> Tables

Table 7. Vdd = +1.8V Rise/Fall Times for Specific C<sub>LOAD</sub>

| Rise/Fall Time Typ (ns)            |   |       |       |       |       |  |  |  |
|------------------------------------|---|-------|-------|-------|-------|--|--|--|
| Drive Strength \ C <sub>LOAD</sub> | Drive Strength \ C <sub>LOAD</sub> 5 pF 15 pF 30 pF 45 pF 60 pF |       |       |       |       |  |  |  |
| L                                  | 6.16  | 11.61 | 22.00 | 31.27 | 39.91 |  |  |  |
| Α                                  | 3.19  | 6.35  | 11.00 | 16.01 | 21.52 |  |  |  |
| R                                  | 2.11  | 4.31  | 7.65  | 10.77 | 14.47 |  |  |  |
| В                                  | 1.65  | 3.23  | 5.79  | 8.18  | 11.08 |  |  |  |
| T                                  | 0.93  | 1.91  | 3.32  | 4.66  | 6.48  |  |  |  |
| E                                  | 0.78  | 1.66  | 2.94  | 4.09  | 5.74  |  |  |  |
| U                                  | 0.70  | 1.48  | 2.64  | 3.68  | 5.09  |  |  |  |
| F or "0": default                  | 0.65  | 1.30  | 2.40  | 3.35  | 4.56  |  |  |  |

Table 8. Vdd = +2.5V Rise/Fall Times for Specific  $C_{LOAD}$ 

| Rise/Fall Time Typ (ns)            |      |       |       |       |       |  |  |
|------------------------------------|------|-------|-------|-------|-------|--|--|
| Drive Strength \ C <sub>LOAD</sub> | 5 pF | 15 pF | 30 pF | 45 pF | 60 pF |  |  |
| L                                  | 4.13 | 8.25  | 12.82 | 21.45 | 27.79 |  |  |
| Α                                  | 2.11 | 4.27  | 7.64  | 11.20 | 14.49 |  |  |
| R                                  | 1.45 | 2.81  | 5.16  | 7.65  | 9.88  |  |  |
| В                                  | 1.09 | 2.20  | 3.88  | 5.86  | 7.57  |  |  |
| T                                  | 0.62 | 1.28  | 2.27  | 3.51  | 4.45  |  |  |
| E or "0": default                  | 0.54 | 1.00  | 2.01  | 3.10  | 4.01  |  |  |
| U                                  | 0.43 | 0.96  | 1.81  | 2.79  | 3.65  |  |  |
| F                                  | 0.34 | 0.88  | 1.64  | 2.54  | 3.32  |  |  |

Table 9. Vdd = +2.8V Rise/Fall Times for Specific C<sub>LOAD</sub>

|                                    |       |       |       | -     |       |  |  |  |
|------------------------------------|-------|-------|-------|-------|-------|--|--|--|
| Rise/Fall Time Typ (ns)            |       |       |       |       |       |  |  |  |
| Drive Strength \ C <sub>LOAD</sub> | 45 pF | 60 pF |       |       |       |  |  |  |
| L                                  | 3.77  | 7.54  | 12.28 | 19.57 | 25.27 |  |  |  |
| Α                                  | 1.94  | 3.90  | 7.03  | 10.24 | 13.34 |  |  |  |
| R                                  | 1.29  | 2.57  | 4.72  | 7.01  | 9.06  |  |  |  |
| В                                  | 0.97  | 2.00  | 3.54  | 5.43  | 6.93  |  |  |  |
| T                                  | 0.55  | 1.12  | 2.08  | 3.22  | 4.08  |  |  |  |
| E or "0": default                  | 0.44  | 1.00  | 1.83  | 2.82  | 3.67  |  |  |  |
| U                                  | 0.34  | 0.88  | 1.64  | 2.52  | 3.30  |  |  |  |
| F                                  | 0.29  | 0.81  | 1.48  | 2.29  | 2.99  |  |  |  |

Table 10. Vdd = +3.0V Rise/Fall Times for Specific C<sub>LOAD</sub>

| Rise/Fall Time Typ (ns)                          |      |      |       |       |       |  |  |
|--|------|------|-------|-------|-------|--|--|
| Drive Strength \ CLOAD 5 pF 15 pF 30 pF 45 pF 60 |      |      |       |       |       |  |  |
| L  | 3.60 | 7.21 | 11.97 | 18.74 | 24.30 |  |  |
| Α  | 1.84 | 3.71 | 6.72  | 9.86  | 12.68 |  |  |
| R  | 1.22 | 2.46 | 4.54  | 6.76  | 8.62  |  |  |
| В  | 0.89 | 1.92 | 3.39  | 5.20  | 6.64  |  |  |
| T or "0": default                                | 0.51 | 1.00 | 1.97  | 3.07  | 3.90  |  |  |
| E  | 0.38 | 0.92 | 1.72  | 2.71  | 3.51  |  |  |
| U  | 0.30 | 0.83 | 1.55  | 2.40  | 3.13  |  |  |
| F  | 0.27 | 0.76 | 1.39  | 2.16  | 2.85  |  |  |

Table 11. Vdd = +3.3V Rise/Fall Times for Specific C<sub>LOAD</sub>

| Rise/Fall Time Typ (ns)            |   |      |       |       |       |  |  |  |
|------------------------------------|---|------|-------|-------|-------|--|--|--|
| Drive Strength \ C <sub>LOAD</sub> | Orive Strength \ C <sub>LOAD</sub> 5 pF         15 pF         30 pF         45 pF         60 pF |      |       |       |       |  |  |  |
| L                                  | 3.39  | 6.88 | 11.63 | 17.56 | 23.59 |  |  |  |
| Α                                  | 1.74  | 3.50 | 6.38  | 8.98  | 12.19 |  |  |  |
| R                                  | 1.16  | 2.33 | 4.29  | 6.04  | 8.34  |  |  |  |
| В                                  | 0.81  | 1.82 | 3.22  | 4.52  | 6.33  |  |  |  |
| T or "0": default                  | 0.46  | 1.00 | 1.86  | 2.60  | 3.84  |  |  |  |
| E                                  | 0.33  | 0.87 | 1.64  | 2.30  | 3.35  |  |  |  |
| U                                  | 0.28  | 0.79 | 1.46  | 2.05  | 2.93  |  |  |  |
| F                                  | 0.25  | 0.72 | 1.31  | 1.83  | 2.61  |  |  |  |

# MO1602

# Low Power, Standard Frequency Oscillator



#### Pin 1 Configuration Options (OE, ST, or NC)

Pin 1 of the MO1602 can be factory-programmed to support three modes: Output Enable (OE), standby (ST) or No Connect (NC). These modes can also be programmed with the Time Machine using field programmable devices.

#### **Output Enable (OE) Mode**

In the OE mode, applying logic Low to the OE pin only disables the output driver and puts it in Hi-Z mode. The core of the device continues to operate normally. Power consumption is reduced due to the inactivity of the output. When the OE pin is pulled High, the output is typically enabled in <1  $\mu s$ .

# Standby (ST) Mode

In the ST mode, a device enters into the standby mode when Pin 1 pulled Low. All internal circuits of the device are turned off. The current is reduced to a standby current, typically in the range of a few  $\mu A$ . When  $\overline{ST}$  is pulled High, the device goes through the "resume" process, which can take up to 5 ms.

#### No Connect (NC) Mode

In the NC mode, the device always operates in its normal mode and outputs the specified frequency regardless of the logic level on pin 1.

Table 12 below summarizes the key relevant parameters in the operation of the device in OE,  $\overline{ST}$ , or NC mode.

Table 12. OE vs. ST vs. NC

|   | OE      | ST                | NC      |
|---|---------|-------------------|---------|
| Active current 20 MHz (max, +1.8V)            | +4.1 mA | +4.1 mA           | +4.1 mA |
| OE disable current (max. +1.8V)               | +4.0 mA | N/A               | N/A     |
| Standby current (typical +1.8V)               | N/A     | +0.6 µA           | N/A     |
| OE enable time at 20 MHz (max)                | 200 ns  | N/A               | N/A     |
| Resume time from standby (max, all frequency) | N/A     | 5 ms              | N/A     |
| Output driver in OE disable/standby mode      | High Z  | weak<br>pull-down | N/A     |

## **Output on Startup and Resume**

The MO1602 comes with gated output. Its clock output is accurate to the rated frequency stability within the first pulse from initial device startup or resume from the standby mode.

In addition, the MO1602 features "no runt" pulses and "no glitch" output during startup or resume as shown in the waveform captures in Figure 17 and Figure 18.

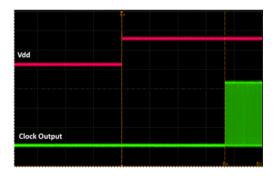


Figure 17. Startup Waveform vs. Vdd

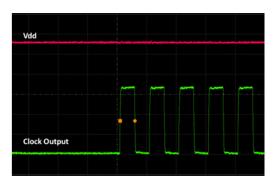


Figure 18. Startup Waveform vs. Vdd (Zoomed-in View of Figure 17)

# Instant Samples with Time Machine and Field Programmable Oscillators

KDS supports a field programmable version of the MO1602 low power oscillator for fast prototyping and real time customization of features. The field programmable devices (FP devices) are available for all five standard MO1602 package sizes and can be configured to one's exact specification using the Time Machine II, an USB powered MEMS oscillator programmer.

#### Customizable Features of the MO1602 FP Devices Include

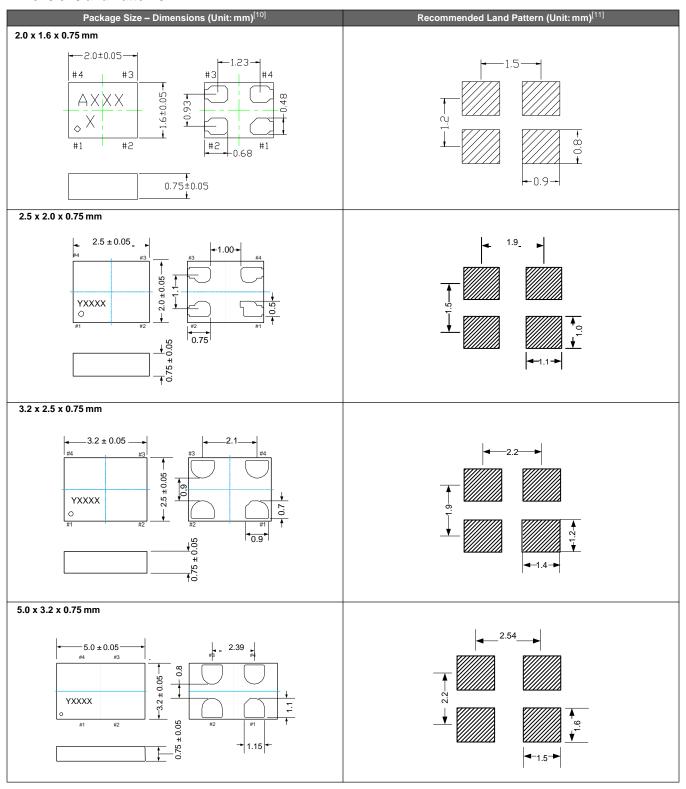
- 52 standard frequencies between 3.75 MHz and 77.76 MHz (Refer to the frequency list on page 12)
- Three frequency stability options, ±20 ppm, ±25 ppm, ±50 ppm
- Two operating temperatures, -20 to 70°C or -40 to 85°C
- Six supply voltage options, +1.8V, +2.5V, +2.8V, +3.0V, +3.3V and +2.25 to +3.63V continuous
- · Output drive strength
- · OE. ST or NC mode

For more information regarding KDS's field programmable solutions, contact KDS.

MO1602 is typically factory-programmed percustomer ordering codes for volume delivery.

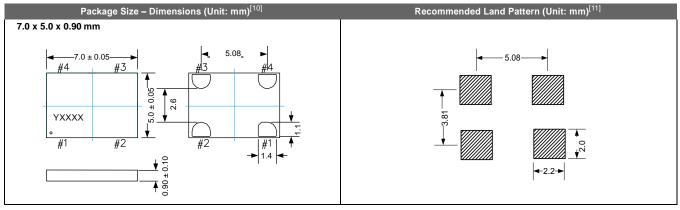


# **Dimensions and Patterns**





# **Dimensions and Patterns**

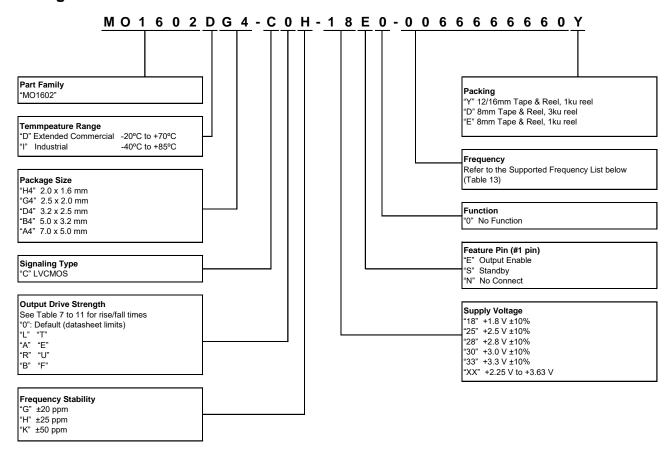


#### Notes

- 10. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 11. A capacitor of value 0.1  $\mu\text{F}$  or higher between Vdd and GND is required.



# **Ordering Information**



**Table 13. List of Supported Frequencies** 

| 3.75 MHz     | 4 MHz     | 4.096MHz      | 6 MHz      | 7.328MHz   | 8.192 MHz | 10 MHz        | 12 MHz     | 14 MHz      |
|--------------|-----------|---------------|------------|------------|-----------|---------------|------------|-------------|
| 18.432 MHz   | 19.2 MHz  | 20 MHz        | 24 MHz     | 24.576 MHz | 25 MHz    | 25.000625 MHz | 26 MHz     | 27 MHz      |
| 28.6363 MHz  | 30 MHz    | 31.25 MHz     | 32.768 MHz | 33 MHz     | 33.3 MHz  | 33.33 MHz     | 33.333 MHz | 33.3333 MHz |
| 33.33333 MHz | 35.84 MHz | 37. 5 MHz     | 38 MHz     | 38.4 MHz   | 40 MHz    | 40.5 MHz      | 48 MHz     | 50 MHz      |
| 54 MHz       | 60 MHz    | 62.5 MHz      | 65 MHz     | 66 MHz     | 66.6 MHz  | 66.66 MHz     | 66.666 MHz | 66.6666 MHz |
| 66.66666 MHz | 72 MHz    | 74.175824 MHz | 74.176 MHz | 74.25 MHz  | 75 MHz    | 77.76 MHz     |            |             |

Table 14. Ordering Codes for Supported Tape & Reel Packing Method

| Device Size<br>(mm x mm) | 16 mm T&R (3ku) | 16 mm T&R (1ku) | 12 mm T&R (3ku) | 12 mm T&R (1ku) | 8 mm T&R (3ku) | 8 mm T&R (1ku) |
|--------------------------|-----------------|-----------------|-----------------|-----------------|----------------|----------------|
| 2.0 x 1.6                | -               | -               | -               | -               | D              | Е              |
| 2.5 x 2.0                | _               | -               | -               | -               | D              | Е              |
| 3.2 x 2.5                | _               | -               | -               | -               | D              | Е              |
| 5.0 x 3.2                | -               | -               | -               | Υ               | -              |                |
| 7.0 x 5.0                | -               | Υ               | _               | -               | -              | _              |

# MO1602 Low Power, Standard Frequency Oscillator



# **Revision History**

# Table 15. Datasheet Version and Change Log

| Version | Release Date | Change Summary   |
|---------|--------------|--|
| 0.9     | 04/01/2014   | Preliminary  |
| 1.0     | 05/04/2014   | Removed preliminary Updated max spec for current consumption and OE disable current Updated the maximum operating junction temperature Updated the current consumption and OE disable current in Table 12 Updated performance plots 8 and 10 Revised the formula for calculating the max frequency with different rise/fall time options |
| 1.01    | 05/07/2015   | Added 20 MHz to the frequency selection     Revised the Electrical Characteristics, Timing Diagrams and Performance Plots     Revised 2016 PKG diagram   |
| 1.02    | 06/18/2015   | Added 16 mm T&R information to Table 14     Revised 12 mm T&R information to Table 14  |
| 1.03    | 08/30/2016   | Revised part number example in the ordering information  |
| 1.04    | 01/11/2017   | Revised 2520 package land pattern  |